# RENESAS

# DATASHEET

FN9087 Rev 2.00

July 25, 2005

# ISL6801

High Voltage Bootstrap High Side Driver

The ISL6801 is a single monolithic, inverting bootstrap driver. Its floating Level Shifter Section is optimized for the control of N-Channel Power MOSFETs in high side configurations with Bus Voltages up to 120VDC from a 5V Controller Output. It features two output stages pinned out separately to allow independent control of rise and fall times. To ensure static DC operation an integrated recharge path charges the bootstrap cap while the driver is switched off. A pull-up resistor forces the input low when no control signal is applied. The supply voltage is monitored to guarantee faultless operation at start-up.

## **Ordering Information**

PART NUMBER	TEMP. RANGE ( <sup>o</sup> C)	PACKAGE	PKG. DWG. #
ISL6801AB	-40 to 125	8 Ld SOIC	M8.15
ISL6801AB-T	-40 to 125	8 Ld SOIC Tape and Reel	M8.15

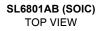
## Features

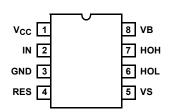
- Single Bootstrap High Side Driver
- Bootstrap Supply Max Voltage..... 120VDC
- Switching Frequency ......100kHz
- Active Low Input
- Separate Reset Input
- Recharge Path for Static Operation
- Separate High and Low Gate Drive Outputs Allow Independent Turn ON/OFF Time Control
- Supply Undervoltage Protection
- Space Saving SO-8 Package
- Wide Operating Temperature Range

### Applications

- Driver for N-Channel MOSFETs in High Side Configurations that Control Ground Referenced Loads
- Drives Solenoids, Motors, Relays and Lamps in Automotive Applications

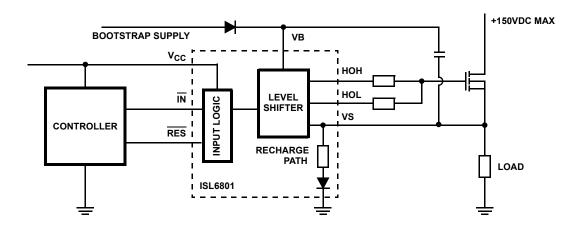
## Pinout



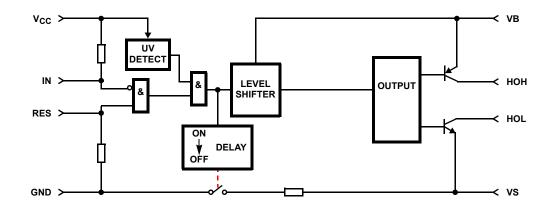




## Typical Application Block Diagram



## Functional Block Diagram



## **Pin Descriptions**

PIN NUMBER	SYMBOL	DESCRIPTION			
1	V <sub>CC</sub>	Driver Supply, Typical 5.0V			
2	IN	river Control Signal Input			
3	GND	round			
4	RES	Driver Enable Signal Input ('RESET')			
5	VS	MOSFET Source Connection			
6	HOL	MOSFET Gate Low Connection			
7	НОН	MOSFET Gate High Connection			
8	VB	Driver Output Stage Supply			

#### NOTE:

The HOL and HOH are the low respective high gate drive output pins. The turn on and turn off time of the external MOSFET could be controlled by using different resistance values for high and low signal.



#### **Absolute Maximum Ratings**

Supply Voltage, V <sub>CC</sub> 16V
Driver Output Stage Voltage, V <sub>B</sub> (Referred to GND)130V
Source Reference Voltage, V <sub>S</sub>
(-5V for 0.5ms, MOSFET Off)
(Max) 120V
ESD Rating, V <sub>ESD</sub>
Human Body Model (Min) 820V
(Per MIL-STD-883 Method 3015.7)

#### **Operating Conditions**

Temperature Range	-40°C to 125°C
Supply Voltage Range (Max)	4.5V to 6.5V

### **Thermal Information**

Thermal Resistance (Typical, Note 1)	$\theta_{JA}$ (°C/W)
SOIC Package	90
Maximum Junction Temperature (Plastic Package)	
Maximum Storage Temperature Range	<sup>o</sup> C to 150 <sup>o</sup> C
Maximum Lead Temperature (Soldering 10s)	245 <sup>0</sup> C
(SOIC Lead Tips Only)	

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

#### NOTE:

1.  $\theta_{JA}$  is measured with the component mounted on a high effective thermal conductivity test board in free air. See Tech Brief TB379 for details.

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNITS
Operating Temperature Range	T <sub>A</sub>		-40	-	125	°C
Source Reference Voltage	VS	-1.8V Continuous, VB/V <sub>OH</sub> must stay low, IN = 0V, RES = 5V, V <sub>CC</sub> = 4.5V and 6.5V, VB = 5V and 12V, (Load R = 50 $\Omega$ , C = 6.8nF) T <sub>A</sub> = -40 to 125 <sup>o</sup> C	-1.5	-	120	V
Supply Voltage (Note 2)	V <sub>CC</sub>		4.5	-	6.5	V
Driver Output Supply	V <sub>VB - VS</sub>	Ident. to V <sub>GS</sub> of MOSFET Device	4.0	8.5	16.0	V
	V <sub>VB</sub> - GND	Functional	2.0	-	-	V
Switching Frequency	f	Guaranteed by Design	100	-	-	kHz
Voltage Transconductance (Note 3)	dVs/dt		-	-	500	V/µs
Peak Gate Drive Current	I <sub>HOpeak</sub>	Sink/Source Current VB = 5V and 16V, 100ns	-	200	-	mA
Continuous Gate Drive Current (Note 3)	I <sub>HOcont</sub>	Sink/Source Current Continuous	6.5	8	-	mA
Gate Drive Level LOW	V <sub>HOL, VS</sub>	IN at H, $I_{HO}$ = 1mA, VB-VS = 5V and 16V	-	-	0.3	V
Gate Drive Level LOW	V <sub>HOL, VS</sub>	IN at H, I <sub>HO</sub> = 100mA	-	-	2.2	V
Gate Drive Level HIGH	V <sub>VB, HOH</sub>	IN at L, $I_{HO}$ = 1mA, VB-VS = 5V and 16V	-	-	0.5	V
Gate Drive Level HIGH	V <sub>VB, HOH</sub>	IN at L, I <sub>HO</sub> = 100mA	-	-	2.2	V
Total IN to Output Delay (Figure 1)	td <sub>IN-HOH</sub> , L	at $V_{CC} = 5.0V$ , RES = 5V, Output Trigger Level: 3.5V ON at VB = 5V, 1.0V OFF at VB = 16V, Input 2.5V (Load R = 50 $\Omega$ , C = 6.8nF)	-	1.0	3.0	μs
Total RES to Output Delay (Figure 2)	td <sub>RES</sub> - HOH, L	VB-VS = 5V and 16V, (Load R = 50Ω, C = 6.8nF)	-	1.0	3.0	μS
Output Rise/Fall Times	<sup>t</sup> HOH, L Fall/Rise	VB-VS = 5V (Load R = 50Ω, C = 6.8nF)	-	100	500	ns
		VB-VS = 16V	-	200	500	ns
VB Drop Voltage (Figure 4, Note 4)	VB <sub>DROP</sub>	VB-VS = 9.0V, $C_{100} = 1\mu$ F, (Load R = 50 $\Omega$ , C = 6.8nF)	-	100	210 (Note 5)	mV

#### Electrical Specifications All values are over full temperature range.



#### Electrical Specifications All values are over full temperature range. (Continued)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	ТҮР	MAX	UNITS
VB Input Current (Note 6)	I <sub>VB</sub>	Static Current, VB-VS = 8.5V, $V_{CC}$ = 5V, IN = 0V, RES = 5V, (Load R = 50 $\Omega$ , C = 6.8nF)	300	750	875	μΑ
VB Input Current	IVB	$I_{VB} \qquad \begin{array}{l} \text{Static Current, VB-VS} = 8.5V, \\ V_{CC} = 5V, \text{ IN} = 0V, \\ \text{RES} = 0V, \text{ (Load R} = 50\Omega, \text{ C} = 6.8\text{nF}) \end{array}$		550	700	μA
Driver Supply Current	lvcc	at V <sub>CC</sub> = 4.5V and 6.5V (Load R = 50 $\Omega$ , C = 6.8nF)	-	1.2	2.5	mA
Input Threshold LOW (Note 7)	IN <sub>LOW</sub>	$V_{CC} = 4.5V$ and $6.5V$	1.4	-	-	V
Input Threshold HIGH (Note 7)	IN <sub>HIGH</sub>	V <sub>CC</sub> = 4.5V and 6.5V	-	-	3.0	V
Enable Threshold LOW (Note 7)	RESLOW	V <sub>CC</sub> = 4.5V and 6.5V	1.4	-	-	V
Enable Threshold HIGH (Note 7)	RES <sub>HIGH</sub>	V <sub>CC</sub> = 4.5V and 6.5V	-	-	3.0	V
Input Impedance at IN	R <sub>IN</sub>	at $V_{CC}$ = 5.0V, RES = 5V, IN = 0V, VB = 12V	60	100	170	kΩ
Input Impedance at RES	R <sub>RES</sub>	at $V_{CC}$ = 5.0V, RES = 5V, IN = 0V, VB = 12V	60	100	170	kΩ
Logic Input Current at RES (Note 8)	IRES	at Logic LOW Response HIGH	-0.1	-	1.0	mA
Undervoltage Shutdown Threshold	V <sub>UV</sub>	V <sub>CC</sub> to GND, Incl. Hyst.	-	3.5	-	V
Recharge Resistance (Note 9)	R <sub>recharge</sub>	$\label{eq:VB} \begin{array}{l} VB=VS=HOH=HOL=7V,RES=5V,\\ IN=5V,V_{CC}=4.5V\text{ and }6V \end{array}$	70	170	350	Ω
Recharge Turn On Delay (Note 9)	tRechargeON		7	10	15	μs
Recharge Turn Off Delay	t <sub>Recharge</sub> OFF		-	-	1.5	μs
Recharge Path Voltage Drop	Vdrop	at a Constant Current of 1.0mA	-	-	0.8	V
	Recharge	at a Constant Current of 10mA	-	-	3.5	V

NOTES:

- 2. Shutdown between 3.5V and 4.5V.
- 3. Parametric limits are guaranteed by design, but not tested in production.
- 4. The drop voltage is caused by VB to VS current flow during switching. See Figure 3.
- 5. Assuming  $3\mu s$  switching overlap, time delay use at testing  $100\mu s$ .
- 6. External MOSFET ON or OFF.
- 7. Input and Enable thresholds tested at  $V_{CC}$  = 4.5V and 6.5V, VB = 12V, VS = 0V, IN at 0V, Response RES at 5.0V.
- 8. The defined values are to be considered as a maximum allowed value. The input stage does not need to have sink or source capability.
- The recharge path has to withstand transients in the 120V range for approximately 1µs while injector turn off, causing high power dissipation in the resistor.



## **Timing Diagrams**

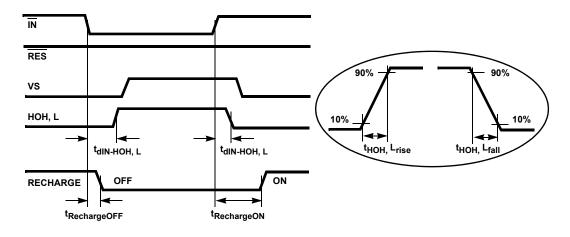


FIGURE 1. INPUT/OUTPUT TIMING DIAGRAM

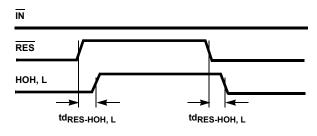


FIGURE 2. RESET TIMING DIAGRAM

VB Drop Voltage Test

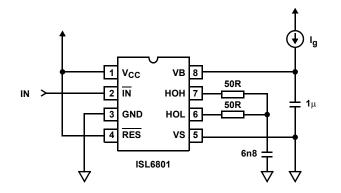
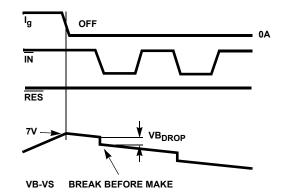
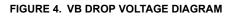


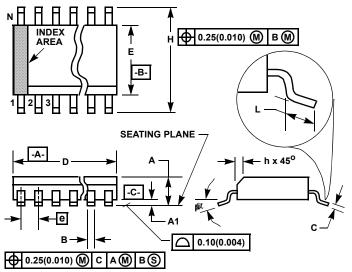
FIGURE 3. VB DROP VOLTAGE TEST CIRCUIT







## Small Outline Plastic Packages (SOIC)



NOTES:

- 1. Symbols are defined in the "MO Series Symbol List" in Section 2.2 of Publication Number 95.
- 2. Dimensioning and tolerancing per ANSI Y14.5M-1982.
- Dimension "D" does not include mold flash, protrusions or gate burrs. Mold flash, protrusion and gate burrs shall not exceed 0.15mm (0.006 inch) per side.
- Dimension "E" does not include interlead flash or protrusions. Interlead flash and protrusions shall not exceed 0.25mm (0.010 inch) per side.
- 5. The chamfer on the body is optional. If it is not present, a visual index feature must be located within the crosshatched area.
- 6. "L" is the length of terminal for soldering to a substrate.
- 7. "N" is the number of terminal positions.
- 8. Terminal numbers are shown for reference only.
- 9. The lead width "B", as measured 0.36mm (0.014 inch) or greater above the seating plane, shall not exceed a maximum value of 0.61mm (0.024 inch).
- 10. Controlling dimension: MILLIMETER. Converted inch dimensions are not necessarily exact.

#### **M8.15** (JEDEC MS-012-AA ISSUE C) 8 LEAD NARROW BODY SMALL OUTLINE PLASTIC PACKAGE

	INCHES		MILLIMETERS		
SYMBOL	MIN	MAX	MIN	MAX	NOTES
А	0.0532	0.0688	1.35	1.75	-
A1	0.0040	0.0098	0.10	0.25	-
В	0.013	0.020	0.33	0.51	9
С	0.0075	0.0098	0.19	0.25	-
D	0.1890	0.1968	4.80	5.00	3
E	0.1497	0.1574	3.80	4.00	4
е	0.050 BSC		1.27 BSC		-
Н	0.2284	0.2440	5.80	6.20	-
h	0.0099	0.0196	0.25	0.50	5
L	0.016	0.050	0.40	1.27	6
Ν	8			8	7
α	0 <sup>0</sup>	8 <sup>0</sup>	0 <sup>0</sup>	8 <sup>0</sup>	-

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